



Advance Information

PE97632

3.2 GHz Delta-Sigma modulated Fractional-N Frequency Synthesizer for Low Phase Noise Applications

Features

- 3.2 GHz operation
- $\div 10/11$ dual modulus prescaler
- Phase detector output
- Serial or Direct mode access
- Frequency selectivity: Comparison frequency / 2^{18}
- Low power — 50 mA at 3.3 V
- Rad-Hard
- Ultra-low phase noise
- 68-lead CQFJ

Product Description

Peregrine's PE97632 is a high performance fractional-N PLL capable of frequency synthesis up to 3.2 GHz. The device is designed for superior phase noise performance while providing an order of magnitude reduction in current consumption, when compared with the existing commercial space PLLs.

The PE97632 features a 10/11 dual modulus prescaler, counters, a delta sigma modulator, and a phase comparator as shown in Figure 1. Counter values are programmable through either a serial interface or directly hard-wired.

The PE97632 is optimized for commercial space applications. Single Event Latch up (SEL) is physically impossible and Single Event Upset (SEU) is better than 10^{-9} errors per bit / day. Fabricated in Peregrine's patented UTSi® (Ultra Thin Silicon) CMOS technology, the PE97632 offers excellent RF performance and intrinsic radiation tolerance.

Figure 1. Block Diagram

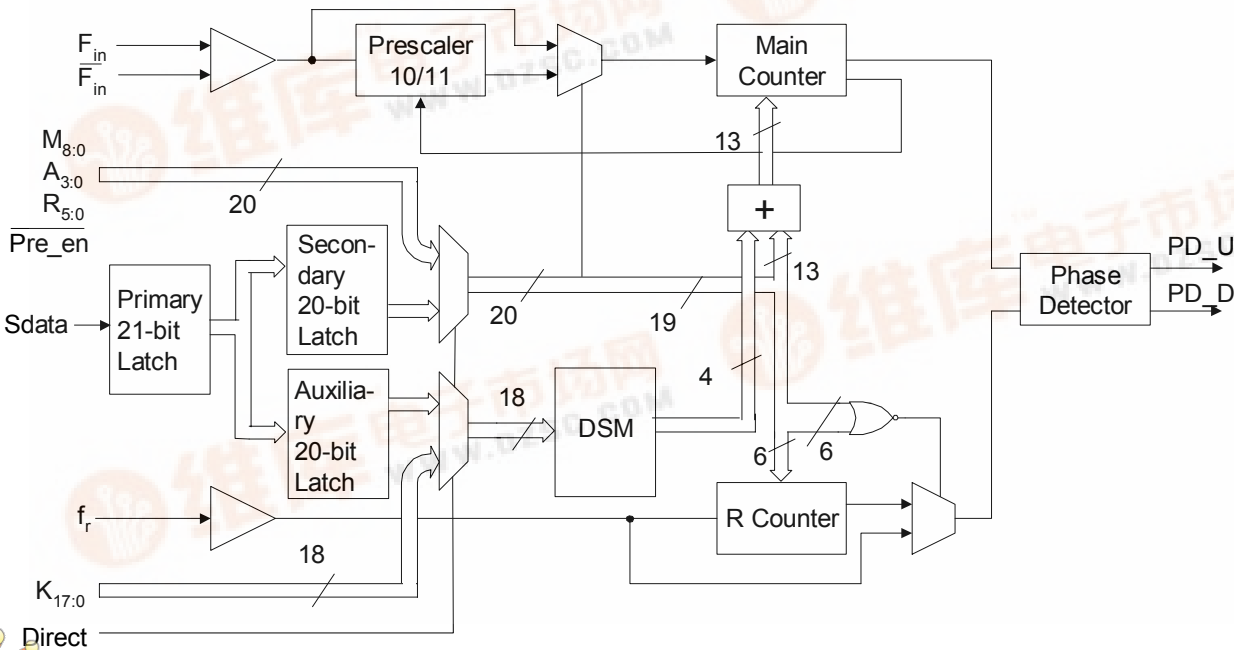
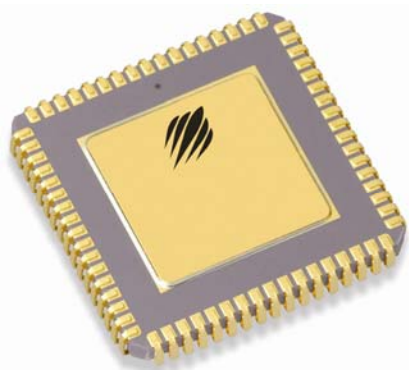
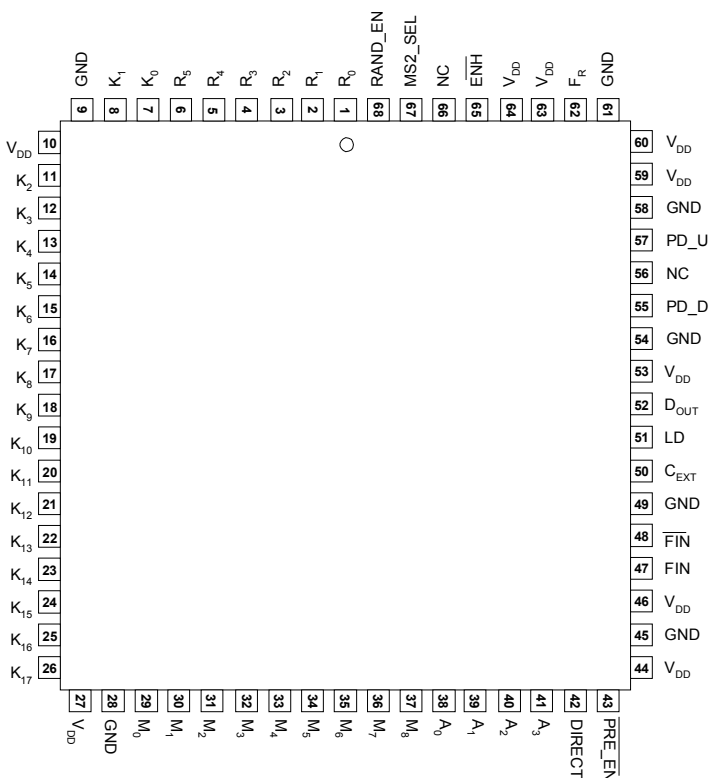


Figure 2. Pin Configuration and package photo

Table 1. Pin Descriptions

| Pin No. | Pin Name | Valid Mode | Type | Description |
|---------|-----------------|------------|----------|--------------------------------|
| 1 | R ₀ | Direct | Input | R Counter bit0 (LSB). |
| 2 | R ₁ | Direct | Input | R Counter bit1. |
| 3 | R ₂ | Direct | Input | R Counter bit2. |
| 4 | R ₃ | Direct | Input | R Counter bit3. |
| 5 | R ₄ | Direct | Input | R Counter bit4. |
| 6 | R ₅ | Direct | Input | R Counter bit5 (MSB). |
| 7 | K ₀ | Direct | Input | K Counter bit0 (LSB). |
| 8 | K ₁ | Direct | Input | K Counter bit1. |
| 9 | GND | | Downbond | Ground |
| 10 | V _{DD} | | (Note 1) | Digital core V _{DD} . |
| 11 | K ₂ | Direct | Input | K Counter bit2. |
| 12 | K ₃ | Direct | Input | K Counter bit3. |
| 13 | K ₄ | Direct | Input | K Counter bit4. |
| 14 | K ₅ | Direct | Input | K Counter bit5. |
| 15 | K ₆ | Direct | Input | K Counter bit6. |

| Pin No. | Pin Name | Valid Mode | Type | Description |
|---------|-----------------|------------|----------|--|
| 16 | K ₇ | Direct | Input | K Counter bit7. |
| 17 | K ₈ | Direct | Input | K Counter bit8. |
| 18 | K ₉ | Direct | Input | K Counter bit9. |
| 19 | K ₁₀ | Direct | Input | K Counter bit10. |
| 20 | K ₁₁ | Direct | Input | K Counter bit11. |
| 21 | K ₁₂ | Direct | Input | K Counter bit12. |
| 22 | K ₁₃ | Direct | Input | K Counter bit13. |
| 23 | K ₁₄ | Direct | Input | K Counter bit14. |
| 24 | K ₁₅ | Direct | Input | K Counter bit15. |
| 25 | K ₁₆ | Direct | Input | K Counter bit16. |
| 26 | K ₁₇ | Direct | Input | K Counter bit17 (MSB). |
| 27 | V _{DD} | | (Note 1) | Digital core V _{DD} . |
| 28 | GND | | Downbond | Ground |
| 29 | M ₀ | Direct | Input | M Counter bit0 (LSB). |
| 30 | M ₁ | Direct | Input | M Counter bit1. |
| 31 | M ₂ | Direct | Input | M Counter bit2. |
| 32 | M ₃ | Direct | Input | M Counter bit3. |
| 33 | M ₄ | Direct | Input | M Counter bit4. |
| | S_WR | Serial | Input | Serial load enable input. While S_WR is "low", Sdata can be serially clocked. Primary register data are transferred to the secondary register on S_WR or Hop_WR rising edge. |
| 34 | M ₅ | Direct | Input | M Counter bit5. |
| | SDATA | Serial | Input | Binary serial data input. Input data entered MSB first. |
| 35 | M ₆ | Direct | Input | M Counter bit6. |
| | SCLK | Serial | Input | Serial clock input. SDATA is clocked serially into the 20-bit primary register (E_WR "low") or the 8-bit enhancement register (E_WR "high") on the rising edge of Sclk. |
| 36 | M ₇ | Direct | Input | M Counter bit7. |
| 37 | M ₈ | Direct | Input | M Counter bit8 (MSB). |
| 38 | A ₀ | Direct | Input | A Counter bit0 (LSB). |
| 39 | A ₁ | Direct | Input | A Counter bit1. |
| | E_WR | Serial | Input | Enhancement register write enable. While E_WR is "high", Sdata can be serially clocked into the enhancement register on the rising edge of Sclk. |
| 40 | A ₂ | Direct | Input | A Counter bit2. |
| 41 | A ₃ | Direct | Input | A Counter bit3 (MSB). |
| 42 | DIRECT | Both | Input | Direct mode select. "High" enables direct mode. "Low" enables serial mode. |
| 43 | Pre_en | Direct | Input | Prescaler enable, active "low". When "high", Fin bypasses the prescaler. |
| 44 | V _{DD} | | (Note 1) | Digital core V _{DD} . |
| 45 | GND | | Downbond | Ground |

| Pin No. | Pin Name | Valid Mode | Type | Description |
|---------|---------------------|------------|----------|---|
| 46 | V _{DD} | | (Note 1) | Prescaler V _{DD} . |
| 47 | F _{in} | Both | Input | Prescaler input from the VCO. 3.2 GHz max frequency. |
| 48 | \overline{F}_{in} | Both | Input | Prescaler complementary input. A bypass capacitor should be placed as close as possible to this pin and be connected in series with a 50 Ω resistor directly to the ground plane. |
| 49 | GND | | Downbond | Ground |
| 50 | CEXT | Both | Output | Logical "NAND" of PD_U and PD_D terminated through an on chip, 2 k Ω series resistor. Connecting Cext to an external capacitor will low pass filter the input to the inverting amplifier used for driving LD. |
| 51 | LD | Both | Output | Lock detect and open drain logical inversion of CEXT. When the loop is in lock, LD is high impedance, otherwise LD is a logic low ("0"). |
| 52 | D _{OUT} | Both | Output | Data out function, enabled in enhancement mode. |
| 53 | V _{DD} | | (Note 1) | Output driver/V _{DD} . |
| 54 | GND | | Downbond | Ground |
| 55 | PD_D | Both | Output | PD_D pulses down when f _p leads f _c . PD_U is driven to GND when CPSEL = "High". |
| 56 | NC | Both | | No Connect |
| 57 | PD_U | Both | Output | PD_U pulses down when f _c leads f _p . PD_D is driven to GND when CPSEL = "High". |
| 58 | GND | | Downbond | Ground |
| 59 | V _{DD} | | (Note 1) | Output driver/V _{DD} . |
| 60 | V _{DD} | | (Note 1) | Phase detector V _{DD} . |
| 61 | GND | | Downbond | Ground |
| 62 | f _r | Both | Input | Reference frequency input. |
| 63 | V _{DD} | | (Note 1) | Reference V _{DD} . |
| 64 | V _{DD} | | (Note 1) | Digital core V _{DD} . |
| | GND | | Downbond | Ground |
| 65 | \overline{ENH} | Both | Input | Enhancement mode. When asserted low ("0"), enhancement register bits are functional. |
| 66 | NC | Both | | No Connect |
| 67 | MS2_SEL | Both | Input | MASH 1-1 select. "High" selects MASH 1-1 mode. "Low" selects the MASH 1-1-1 mode. |
| 68 | RND_SEL | Both | Input | K register LSB toggle enable. "1" enables the toggling of LSB. This is equivalent to having an additional bit for the LSB of K register. The frequency offset as a result of enabling this bit is the phase detector comparison frequency / 2 ¹⁹ . |

Note 1: All V_{DD} pins are connected by diodes and must be supplied with the same positive voltage level.

Note 2: All digital input pins have 70 k Ω pull-down resistors to ground.

Table 2. Absolute Maximum Ratings

| Symbol | Parameter/Conditions | Min | Max | Units |
|-----------|---------------------------|------|----------------|-------|
| V_{DD} | Supply voltage | -0.3 | 4.0 | V |
| V_I | Voltage on any input | -0.3 | $V_{DD} + 0.3$ | V |
| I_I | DC into any input | -10 | +10 | mA |
| I_O | DC into any output | -10 | +10 | mA |
| T_{stg} | Storage temperature range | -65 | 150 | °C |

Table 3. Operating Ratings

| Symbol | Parameter/Conditions | Min | Max | Units |
|----------|-------------------------------------|------|------|-------|
| V_{DD} | Supply voltage | 2.85 | 3.45 | V |
| T_A | Operating ambient temperature range | -40 | 85 | °C |

Table 4. ESD Ratings

| Symbol | Parameter/Conditions | Level | Units |
|-----------|---------------------------------------|-------|-------|
| V_{ESD} | ESD voltage human body model (Note 1) | 1000 | V |

Note 1: Periodically sampled, not 100% tested. Tested per MIL-STD-883, M3015 C2

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 4.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Table 5. DC Characteristics

$V_{DD} = 3.0\text{ V}$, $-40^\circ\text{ C} < TA < 85^\circ\text{ C}$, unless otherwise specified

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--|---|---|---------------------|-----|---------------------|---------------|
| I_{DD} | Operational supply current; Prescaler enabled | $V_{DD} = 2.85\text{ to }3.45\text{ V}$ | | 50 | | mA |
| I_{DD} | Operational supply current; Prescaler disabled | $V_{DD} = 2.85\text{ to }3.45\text{ V}$ | | 10 | | mA |
| All Digital inputs: K[17:0], R[5:0], M[8:0], A[3:0], Direct, $\overline{\text{Pre_en}}$, $\overline{\text{Rand_en}}$, M2_sel, Cpsel, $\overline{\text{Enh}}$ (contains a 70 k Ω pull-down resistor) | | | | | | |
| V_{IH} | High level input voltage | $V_{DD} = 2.85\text{ to }3.45\text{ V}$ | $0.7 \times V_{DD}$ | | | V |
| V_{IL} | Low level input voltage | $V_{DD} = 2.85\text{ to }3.45\text{ V}$ | | | $0.3 \times V_{DD}$ | V |
| I_{IH} | High level input current | $V_{IH} = V_{DD} = 3.45\text{ V}$ | | | +100 | μA |
| I_{IL} | Low level input current | $V_{IL} = 0, V_{DD} = 3.45\text{ V}$ | -1 | | | μA |
| Reference Divider input: f_r | | | | | | |
| I_{IHR} | High level input current | $V_{IH} = V_{DD} = 3.45\text{ V}$ | | | +100 | μA |
| I_{ILR} | Low level input current | $V_{IL} = 0, V_{DD} = 3.45\text{ V}$ | -100 | | | μA |
| Counter and phase detector outputs: PD_D, PD_U | | | | | | |
| V_{OLD} | Output voltage LOW | $I_{out} = 6\text{ mA}$ | | | 0.4 | V |
| V_{OHD} | Output voltage HIGH | $I_{out} = -3\text{ mA}$ | $V_{DD} - 0.4$ | | | V |
| Digital test outputs: Dout | | | | | | |
| V_{OLD} | Output voltage LOW | $I_{out} = 200\text{ }\mu\text{A}$ | | | 0.4 | V |
| V_{OHD} | Output voltage HIGH | $I_{out} = -200\text{ }\mu\text{A}$ | $V_{DD} - 0.4$ | | | V |
| Lock detect outputs: (Cext, LD) | | | | | | |
| V_{OLC} | Output voltage LOW, Cext | $I_{out} = 0.1\text{ mA}$ | | | 0.4 | V |
| V_{OHC} | Output voltage HIGH, Cext | $I_{out} = -0.1\text{ mA}$ | $V_{DD} - 0.4$ | | | V |
| V_{OLLD} | Output voltage LOW, LD | $I_{out} = 1\text{ mA}$ | | | 0.4 | V |

Table 6. AC Characteristics

$V_{DD} = 3.0\text{ V}$, $-40^\circ\text{ C} < TA < 85^\circ\text{ C}$, unless otherwise specified

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|---|--|----------------------|-----|------|------|--------|
| Control Interface and Latches (see Figures 3, 4) | | | | | | |
| f_{Clk} | Serial data clock frequency | (Note 1) | | | 10 | MHz |
| t_{ClkH} | Serial clock HIGH time | | 30 | | | ns |
| t_{ClkL} | Serial clock LOW time | | 30 | | | ns |
| t_{DSU} | Sdata set-up time to Sclk rising edge | | 10 | | | ns |
| t_{DHLD} | Sdata hold time after Sclk rising edge | | 10 | | | ns |
| t_{PW} | S_WR pulse width | | 30 | | | ns |
| t_{CWR} | Sclk rising edge to S_WR rising edge | | 30 | | | ns |
| t_{CE} | Sclk falling edge to E_WR transition | | 30 | | | ns |
| t_{WRC} | S_WR falling edge to Sclk rising edge | | 30 | | | ns |
| t_{EC} | E_WR transition to Sclk rising edge | | 30 | | | ns |
| Main Divider (Including Prescaler) (Note 4) | | | | | | |
| F_{in} | Operating frequency | | 275 | | 3200 | MHz |
| P_{Fin} | Input level range | External AC coupling | -5 | | 5 | dBm |
| Main Divider (Prescaler Bypassed) (Note 4) | | | | | | |
| F_{in} | Operating frequency | | 50 | | 300 | MHz |
| P_{Fin} | Input level range | External AC coupling | -5 | | 5 | dBm |
| Reference Divider | | | | | | |
| f_r | Operating frequency | (Note 3) | | | 100 | MHz |
| P_{fr} | Reference input power (Note 2) | Single ended input | -2 | | | dBm |
| Phase Detector | | | | | | |
| f_c | Comparison frequency | (Note 3) | | | 50 | MHz |
| SSB Phase Noise ($F_{\text{in}} = 1.9\text{ GHz}$, $f_r = 20\text{ MHz}$, $f_c = 20\text{ MHz}$, $\text{LBW} = 50\text{ kHz}$, $V_{\text{DD}} = 3.3\text{ V}$, $\text{Temp} = 25^\circ\text{ C}$) (Note 4) | | | | | | |
| Φ_{N} | Phase Noise | 1 kHz Offset | | -97 | | dBc/Hz |
| Φ_{N} | Phase Noise | 10 kHz Offset | | -102 | | dBc/Hz |

Note 1: f_{clk} is verified during the functional pattern test. Serial programming sections of the functional pattern are clocked at 10 MHz to verify f_{clk} specification.

Note 2: CMOS logic levels can be used to drive reference input if DC coupled. Voltage input needs to be a minimum of 0.5 Vp-p. For optimum phase noise performance, the reference input falling edge rate should be faster than 80mV/ns.

Note 3: Parameter is guaranteed through characterization only and is not tested.

Note 4: Parameter below are not tested for die sales. These parameters are verified during the element evaluation per the die flow.

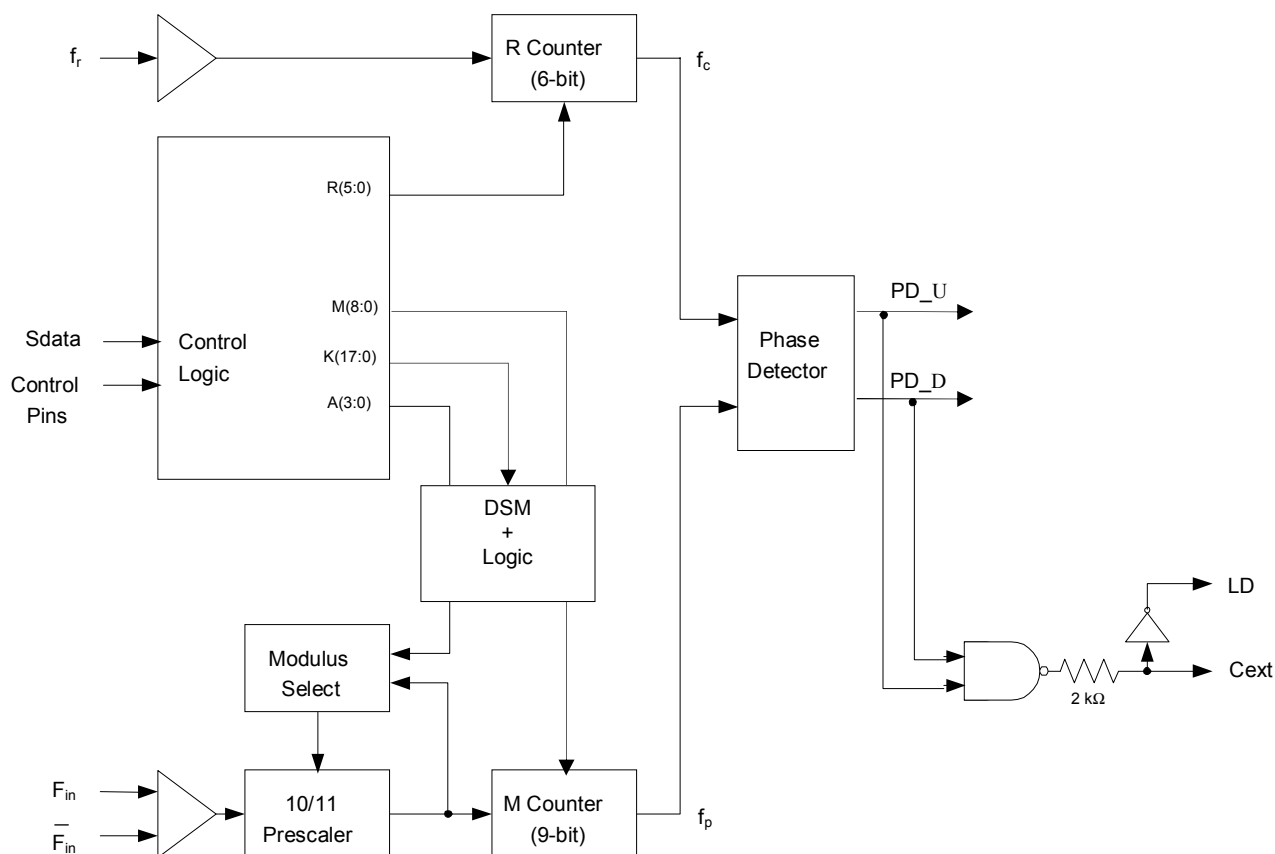
Functional Description

The PE97632 consists of a prescaler, counters, an 18-bit delta-sigma modulator (DSM) and a phase detector. The dual modulus prescaler divides the VCO frequency by either 10 or 11, depending on the value of the modulus select. Counters “R” and “M” divide the reference and prescaler output, respectively, by integer values stored in a 20-bit register. An additional counter (“A”) is used in the modulus select logic. The DSM

modulates the “A” counter outputs in order to achieve the desired fractional step.

The phase-frequency detector generates up and down frequency control signals. Data is written into the internal registers via the three wire serial bus. There are also various operational and test modes and a lock detect output.

Figure 3. Functional Block Diagram



Main Counter Chain

Normal Operating Mode

Setting the Pre_en control bit “low” enables the ÷10/11 prescaler. The main counter chain then divides the RF input frequency (F_{in}) by an integer or fractional number derived from the values in the “M”, “A” counters and the DSM input word K. The accumulator size is 18 bit, so the fractional value is fixed from the ratio $K/2^{18}$. There is an additional bit in the DSM that acts like an extra bit (19th bit). This bit is enabled by asserting the pin RAND_SEL to “high”. Enabling this bit has the benefit of reducing the spurious levels. However, a small frequency offset will occur. This positive frequency offset is calculated with the following equation.

$$f_{offset} = (f_r / (R + 1)) / 2^{19} \quad (1)$$

All of the following equations do not take into account this frequency offset. If this offset is important to a specific frequency plan, appropriate account needs to be taken.

In the normal mode, the output from the main counter chain (f_p) is related to the VCO frequency (F_{in}) by the following equation:

$$f_p = F_{in} / [10 \times (M + 1) + A + K/2^{18}] \quad (2)$$

where $A \leq M + 1$, $1 \leq M \leq 511$

When the loop is locked, F_{in} is related to the reference frequency (f_r) by the following equation:

$$F_{in} = [10 \times (M + 1) + A + K/2^{18}] \times (f_r / (R+1)) \quad (3)$$

where $A \leq M + 1$, $1 \leq M \leq 511$

A consequence of the upper limit on A is that F_{in} must be greater than or equal to $90 \times (f_r / (R+1))$ to obtain contiguous channels. The A counter can accept values as high as 15, but in typical operation it will cycle from 0 to 9 between increments in M.

Programming the M counter with the minimum allowed value of “1” will result in a minimum M counter divide ratio of “2”.

Prescaler Bypass Mode (*)

Setting the frequency control register bit Pre_en “high” allows F_{in} to bypass the ÷10/11 prescaler.

In this mode, the prescaler and A counter are powered down, and the input VCO frequency is divided by the M counter directly. The following equation relates F_{in} to the reference frequency f_r :

$$F_{in} = (M + 1) \times (f_r / (R+1)) \quad (4)$$

where $1 \leq M \leq 511$

(*) Only integer mode

In frequency bypass mode, neither A counter or K counter is used. Therefore, only integer-N operation is possible.

Reference Counter

The reference counter chain divides the reference frequency f_r down to the phase detector comparison frequency f_c .

The output frequency of the 6-bit R Counter is related to the reference frequency by the following equation:

$$f_c = f_r / (R + 1) \quad (5)$$

where $0 \leq R \leq 63$

Note that programming R with “0” will pass the reference frequency (f_r) directly to the phase detector.

Register Programming

Serial Interface Mode

While the E_WR input is “low” and the S_WR input is “low”, serial input data (Sdata input), B_0 to B_{20} , are clocked serially into the primary register on the rising edge of Sclk, MSB (B_0) first. The LSB is used as address bit. When “0”, the contents from the primary register are transferred into the secondary register on the rising edge of either S_WR according to the timing diagrams shown in Figure 4. When “1”, data is transferred to the auxiliary register according to the same timing diagram. The secondary register is used to program the various counters, while the auxiliary register is used to program the DSM.

Data are transferred to the counters as shown in Table 8 on page 10.

While the E_WR input is “high” and the S_WR input is “low”, serial input data (Sdata input), B₀ to B₇, are clocked serially into the enhancement register on the rising edge of Sclk, MSB (B₀) first. The enhancement register is double buffered to prevent inadvertent control changes during serial loading, with buffer capture of the serially entered data performed on the falling edge of E_WR according to the timing diagram shown in Figure 4. After the falling edge of E_WR, the data provide control bits as shown in Table 9 on page 10 will have their bit functionality enabled by asserting the Enh input “low”.

Direct Interface Mode

Direct Interface Mode is selected by setting the “Direct” input “high”.

Counter control bits are set directly at the pins as shown in Table 7 and Table 8.

Table 7. Secondary Register Programming

| Interface Mode | Enh | R ₅ | R ₄ | M ₈ | M ₇ | Pre_en | M ₆ | M ₅ | M ₄ | M ₃ | M ₂ | M ₁ | M ₀ | R ₃ | R ₂ | R ₁ | R ₀ | A ₃ | A ₂ | A ₁ | A ₀ | Addr |
|----------------|-----|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
| Direct | 1 | R ₅ | R ₄ | M ₈ | M ₇ | Pre_en | M ₆ | M ₅ | M ₄ | M ₃ | M ₂ | M ₁ | M ₀ | R ₃ | R ₂ | R ₁ | R ₀ | A ₃ | A ₂ | A ₁ | A ₀ | X |
| Serial* | 1 | B ₀ | B ₁ | B ₂ | B ₃ | B ₄ | B ₅ | B ₆ | B ₇ | B ₈ | B ₉ | B ₁₀ | B ₁₁ | B ₁₂ | B ₁₃ | B ₁₄ | B ₁₅ | B ₁₆ | B ₁₇ | B ₁₈ | B ₁₉ | 0 |

*Serial data clocked serially on Sclk rising edge while E_WR “low” and captured in secondary register on S_WR rising edge.

↑
MSB (first in)

↑
(last in) LSB

Table 8. Auxiliary Register Programming

| Interface Mode | Enh | K ₁₇ | K ₁₆ | K ₁₅ | K ₁₄ | K ₁₃ | K ₁₂ | K ₁₁ | K ₁₀ | K ₉ | K ₈ | K ₇ | K ₆ | K ₅ | K ₄ | K ₃ | K ₂ | K ₁ | K ₀ | Rsrv | Rsrv | Addr |
|----------------|-----|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|----------------|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------|
| Direct | 1 | K ₁₇ | K ₁₆ | K ₁₅ | K ₁₄ | K ₁₃ | K ₁₂ | K ₁₁ | K ₁₀ | K ₉ | K ₈ | K ₇ | K ₆ | K ₅ | K ₄ | K ₃ | K ₂ | K ₁ | K ₀ | X | X | X |
| Serial* | 1 | B ₀ | B ₁ | B ₂ | B ₃ | B ₄ | B ₅ | B ₆ | B ₇ | B ₈ | B ₉ | B ₁₀ | B ₁₁ | B ₁₂ | B ₁₃ | B ₁₄ | B ₁₅ | B ₁₆ | B ₁₇ | B ₁₈ | B ₁₉ | 1 |

*Serial data clocked serially on Sclk rising edge while E_WR “low” and captured in secondary register on S_WR rising edge.

↑
MSB (first in)

↑
(last in) LSB

Table 9. Enhancement Register Programming

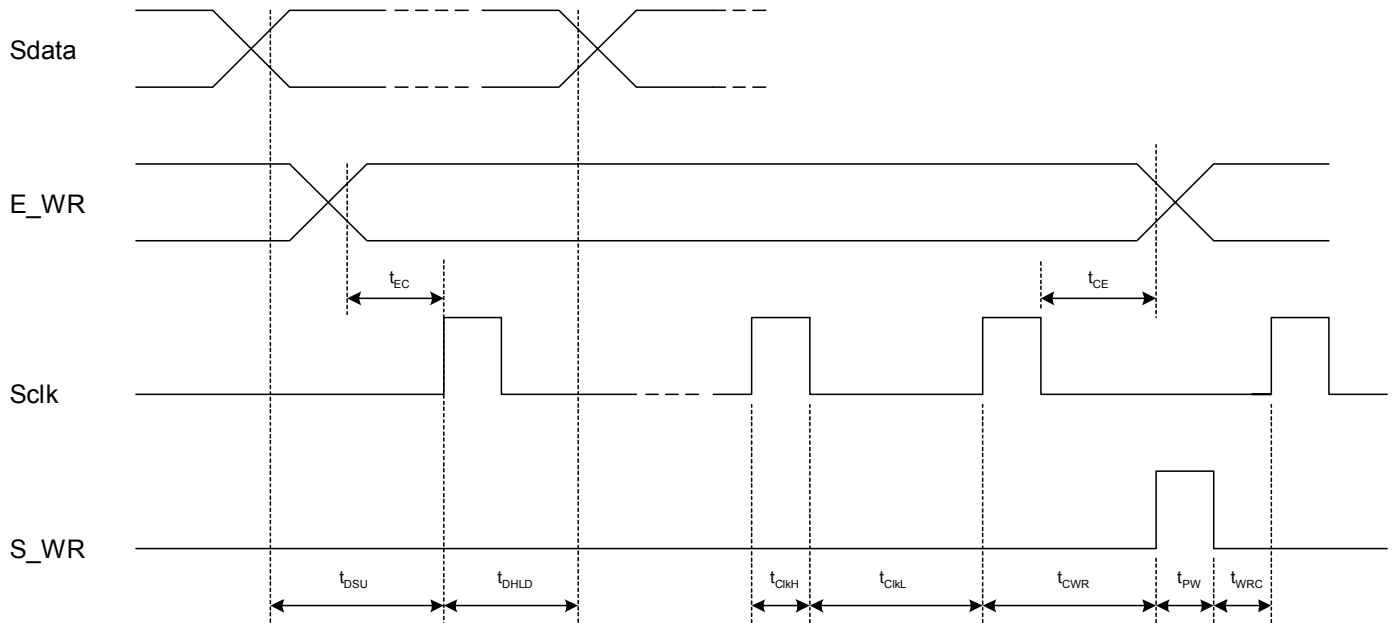
| Interface Mode | Enh | Reserved | Reserved | f _p output | Power Down | Counter load | MSEL output | f _c output | LD Disable |
|----------------|-----|----------------|----------------|-----------------------|----------------|----------------|----------------|-----------------------|----------------|
| Serial* | 0 | B ₀ | B ₁ | B ₂ | B ₃ | B ₄ | B ₅ | B ₆ | B ₇ |

*Serial data clocked serially on Sclk rising edge while E_WR “high” and captured in the double buffer on E_WR falling edge.

↑
MSB (first in)

↑
(last in) LSB

Figure 4. Serial Interface Mode Timing Diagram



Enhancement Register

The functions of the enhancement register bits are shown below with all bits active “high”.

Table 10. Enhancement Register Bit Functionality

| Bit Function | | Description |
|--------------|--------------|--|
| Bit 0 | Reserve ** | Reserved. |
| Bit 1 | Reserve ** | Reserved. |
| Bit 2 | f_p output | Drives the M counter output onto the Dout output. |
| Bit 3 | Power down | Power down of all functions except programming interface. |
| Bit 4 | Counter load | Immediate and continuous load of counter programming. |
| Bit 5 | MSEL output | Drives the internal dual modulus prescaler modulus select (MSEL) onto the Dout output. |
| Bit 6 | f_c output | Drives the reference counter output onto the Dout output. |
| Bit 7 | LD Disable | Disables the LD pin for quieter operation. |

** Program to 0

Phase Detector

The phase detector is triggered by rising edges from the main Counter (f_p) and the reference counter (f_c). It has two outputs, namely PD_U, and PD_D. If the divided VCO leads the divided reference in phase or frequency (f_p leads f_c), PD_D pulses “low”. If the divided reference leads the divided VCO in phase or frequency (f_c leads f_p), PD_U pulses “low”. The width of either pulse is directly proportional to phase offset between the two input signals, f_p and f_c .

For the UP and DOWN mode, PD_U and PD_D drive an active loop filter which controls the VCO tune voltage. The phase detector gain is equal to $VDD / 2 \pi$.

PD_U pulses cause an increase in VCO frequency and PD_D pulses cause a decrease in VCO frequency, for a positive K_v VCO.

A lock detect output, LD is also provided, via the pin Cext. Cext is the logical “NAND” of PD_U and PD_D waveforms, which is driven through a series 2 k Ω resistor. Connecting Cext to an external shunt capacitor provides low pass filtering of this signal. Cext also drives the input of an internal inverting comparator with an open drain output. Thus LD is an “AND” function of PD_U and PD_D.

Figure 5. Typical Phase Noise

A typical phase noise plot is shown below. “Trace 1” is the smoothed average, and “Trace 2” is the raw data.

Test Conditions: A typical phase noise plot is shown below. “Trace 1” is the smoothed average, and “Trace 2” is the raw data. Test Conditions: $F_{out} = 1.9204$ GHz in MASH 1-1 mode, $F_{comparison} = 20$ MHz, $V_{DD} = 3.3$ V, Temp = 25 C, Loop bandwidth = 50 kHz.

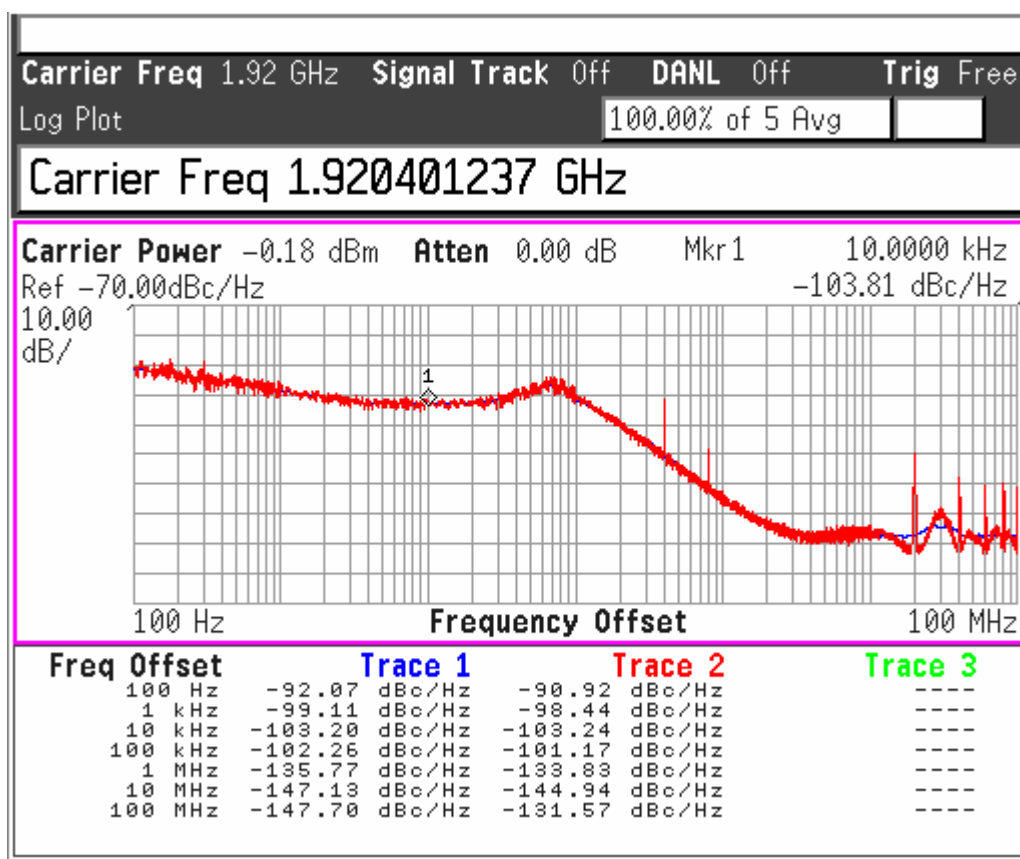
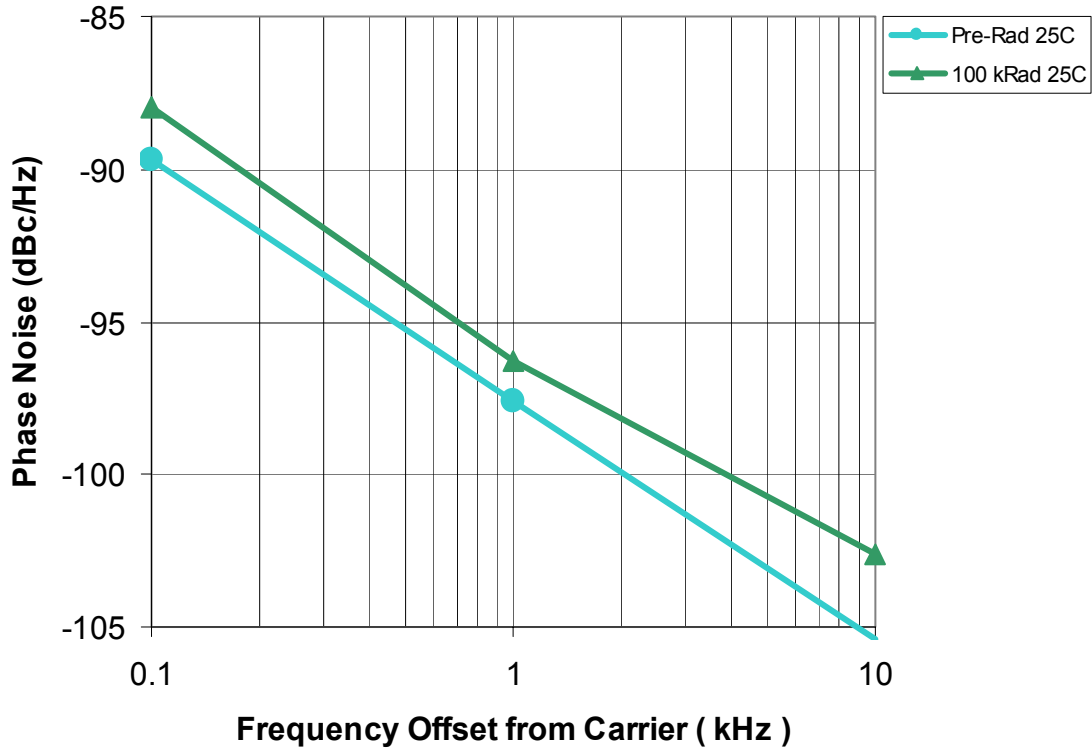


Figure 7. PE97632 Cobalt-60 Radiation Effect on Phase Noise

(Fvco = 1.92 GHz, Fcomp = 20 MHz, LBW = 100 kHz, VDD = 3.3)



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